DECLARATION FOR PATENT APPLICATION

Docket Number (Optional)

MR1115-500

		•) INTITIO-300
As a below named inventor, I hereb	y declar that:	·	
My residence, post office address,	and citizenship are as stated b	pelow next to my name.	
I believe I am the original, first and names are listed below) of the subjection CONTACT ASSEMBLY WITH which is attached hereto unless the	ect matter which is claimed an NON-COPLANARITY ARRA	d for which a patent is sought	, first and joint inventor (if plural on the invention entitled:, the specification of
was filed on Number	as United States Application Number or PCT International Application and was amended on (if applicable)		
I hereby state that I have reviewed amended by any amendment speci I acknowledge the duty to disclose	fically referred to above. Information which is material t	o patentability as defined in 37	' CFR 1.56.
I hereby claim foreign priority benef certificate, or 365(a) of any PCT into America, listed below and have also certificate, or of any PCT internation Prior Foreign Application(s)	ernational application which do identified below, by checking	esignated at least one country the box, any foreign applicati	other than the United States of on for patent or inventor's
(Alumbia)	(0		🗆
(Number)	(Country)	(Day/Month/Year Filed)	•
(Number)	(Country)	(Day/Month/Year Filed)	
I h reby claim the benefit under 35	U.S.C. 119(e) of any United S	states provisional application(s) listed below.
(Application Number)	(Filing Date)		
application designating the United S application is not disclosed in the programmer of 35 U.S.C. 112, I acknowledge the duty to disclose available between the filing date of	rior United States or PCT Inter	rnational application in the mar	oner provided by the first
(Application Number)	(Filing Date)	(Status-p	atented, pending, abandoned)
(Application Number) I hereby appoint the following attornand Trademark Office connected th DAVID R. WOOD, #53,868 Address all telephone calls to Address all correspondence to	erewith: MORTON J. ROSENI DAVID I. KLEIN, ESQ., RE	ecute this application and to tra BERG, ESQ., REG. # 26,049 EG. # 33,253; JUN Y. LEE, ESG at telephone number 410-469 EE RIVE-SUITE 101	; HARRY L. SERNAKER 50 <u>'</u> Q., REG. # 40,262
I hereby declare that all statements and belief are believed to be true; at and the like so made are punishable statem into may jeopardize the valid Full name of sole or first inventor (ginventor's signature Huang Citizenship Tajwan, R.O.C. Mailing Address No. 18, Jung	E-MAIL ADDRESS: rkl@rk made herein of my own know nd further that these statemen by fine or imprisonment, or b lity of the application or any pa iven name, family name) Man - Tung	ledge are true and that all state ts were made with the knowled both, under 18 U.S.C. 1001 and atent issued thereon. IAO JUNG HUANG (HUANG (HUANG (MANG))) Date 1/16/20	Ige that willful false statements d that such willful false IS FAMILY NAME) 004
Full name of second joint inventor, i	f any (given name, family see	'	
Second Inventor's signature	. any (given hame, lamily ham	Date	
Citizenship			
Mailing Address			
Additional Inventors are being	named on separately acceptant	rod abasta attached ba-sts	